





0.2A SBR[®] SURFACE MOUNT SUPER BARRIER RECTIFIER

Features

- Ultra Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability



- Case: DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Dot
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.001 grams



Bottom View



Top View

•

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	100	V
DC Blocking Voltage	V_{RM}		
RMS Reverse Voltage	V _{R(RMS)}	70	V
Average Rectified Output Current (See Figure 1)	Io	250	mA
Non-Repetitive Peak Forward Surge Current 8.3ms	l=a	E	۸
Single Half Sine-Wave Superimposed on Rated Load	IFSM	5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance			
Thermal Resistance, Junction to Ambient (Note 2) T _A = 25°C	$R_{\theta JA}$	270	°C/W
Thermal Resistance, Junction to Ambient (Note 3) T _A = 25°C	$R_{\theta JA}$	235	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

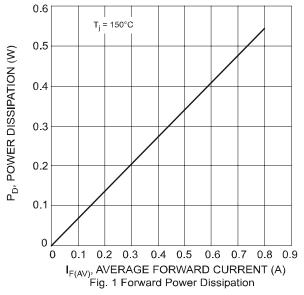
Electrical Characteristics @T_A = 25°C unless otherwise specified

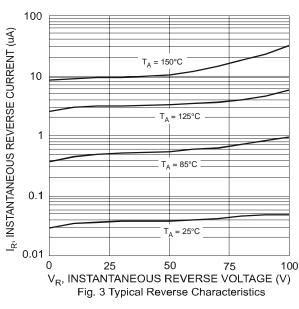
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 4)	V _{(BR)R}	100	-	=	V	I _R = 1mA
Forward Voltage Drop	V _F	-	0.67 0.76 0.60	0.72 0.80 0.65	V	I _F = 100mA, T _J = 25°C I _F = 200mA, T _J = 25°C I _F = 200mA, T _J = 125°C
Leakage Current (Note 4)	I _R	-	0.04 6	1.0 50	I IIA	$V_R = 75V, T_J = 25^{\circ}C$ $V_R = 75V, T_J = 85^{\circ}C$

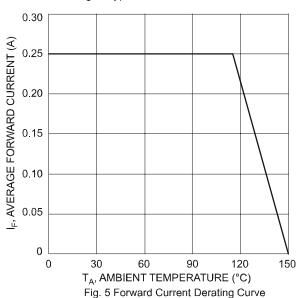
Notes

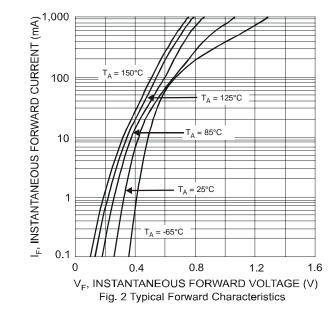
- 1. RoHS revision 13.2.2003. High temperature solder exemption applied, see *EU Directive Annex Note* 7.
- 2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf
- 3. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf
- 4. Short duration pulse test used to minimize self-heating effect.

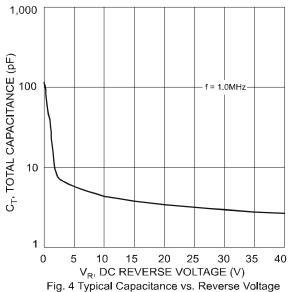


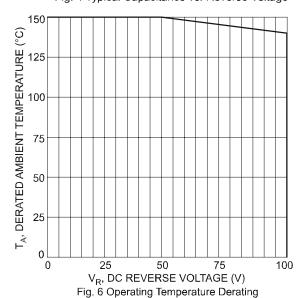












SBR is a registered trademark of Diodes Incorporated.



Ordering Information (Note 5)

Part Number	Case	Packaging
SBR02U100LP-7	DFN1006-2	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

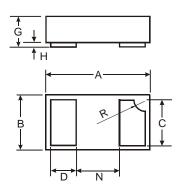
Marking Information





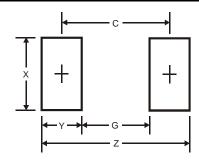
 $\underline{2}$ A, $2\underline{A}$ = Product Type Marking Code Dot Denotes Cathode Side

Package Outline Dimensions



DFN1006-2					
Dim	Min	Max	Тур		
Α	0.95	1.075	1.00		
B 0.55 0.		0.675	0.60		
C 0.45		0.55	0.50		
D	0.20	0.30	0.25		
G	0.47	0.53	0.50		
H 0		0.05	0.03		
N — — 0.4					
R	0.05	0.15	0.10		
All [All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G	0.3
X	0.7
Y	0.4
С	0.7

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.